

BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu PC8232T5N$

SiGe:C LOW NOISE AMPLIFIER FOR GPS

DESCRIPTION

The μ PC8232T5N is a silicon germanium carbon (SiGe:C) monolithic integrated circuit designed as low noise amplifier for GPS. This device exhibits low noise figure and high power gain characteristics, so this IC can improve the sensitivity of GPS receiver. In addition, the μ PC8232T5N which is included output matching circuit contributes to reduce external components and system size.

The package is a 6-pin plastic TSON (Thin Small Qut-line Non-leaded) suitable for surface mount.

This IC is manufactured using our UHS4 (Ultra High Speed Process) SiGe:C bipolar process.

FEATURES

Low noise : NF = 0.95 dB TYP. @ fin = 1 575 MHz
 High gain : GP = 17 dB TYP. @ fin = 1 575 MHz
 Low current consumption : Icc = 3.0 mA TYP. @ Vcc = 3.0 V

• Built-in power-saving function

- High-density surface mounting : 6-pin plastic TSON package (1.5 × 1.5 × 0.37 mm)
- · Included output matching circuit
- Included very robust bandgap regulator (Small Vcc and TA dependence)
- · Included protection circuits for ESD

APPLICATION

· Low noise amplifier for GPS

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPC8232T5N-E2	μPC8232T5N-E2-A	6-pin plastic TSON (Pb-Free)	6L	8 mm wide embossed taping Pin 1, 6 face the perforation side of the tape Qty 3 kpcs/reel

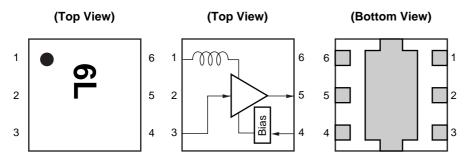
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: µPC8232T5N-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	Vcc
2	GND
3	INPUT
4	Power Save
5	OUTPUT
6	Vcc

Remark Exposed pad: GND

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	Vcc	TA = +25°C	4.0	V
Power-Saving Voltage	V _{PS}	TA = +25°C	4.0	٧
Total Power Dissipation	Ptot		150	mW
Operating Ambient Temperature	TA		-40 to +85	°C
Storage Temperature	T _{stg}		-55 to +150	°C
Input Power	Pin		+10	dBm

RECOMMENDED OPERATING RANGE

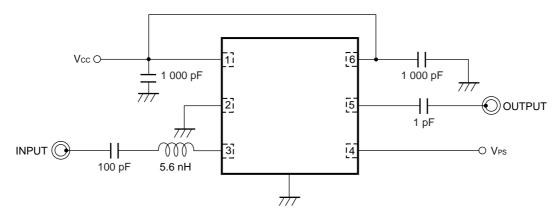
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	2.5	3.0	3.3	V
Operating Ambient Temperature	TA	-40	+25	+85	°C
Power Save Turn-on Voltage	V _{PSon}	1.6	-	Vcc	V
Power Save Turn-off Voltage	VPSoff	0	1	0.4	V

ELECTRICAL CHARACTERISTICS

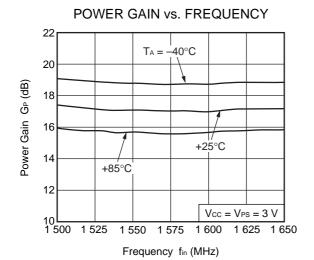
(TA = +25°C, Vcc = VPs = 3.0 V, fin = 1 575 MHz, unless otherwise specified)

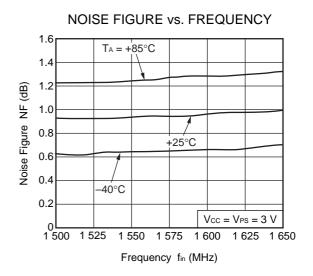
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	Icc	No Signal (VPS = 3.0 V)	2.3	3.0	4.1	mA
		At Power-Saving Mode (VPS = 0 V)	-	-	1	μА
Power Gain	G₽	Pin = -35 dBm	15	17	19	dB
Noise Figure	NF		-	0.95	1.25	dB
Input 3rd Order Distortion Intercept Point	IIP3	fin1 = 1 574 MHz, fin2 = 1 575 MHz	-	-8	-	dBm
Input Return Loss	RLin		7	10	-	dB
Output Return Loss	RLout		10	20	-	dB
Isolation	ISL		_	40	-	dB
Gain 1 dB Compression Input Power	Pin (1 dB)		_	-21	Ī	dBm

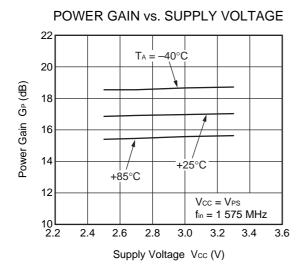
TEST CIRCUIT

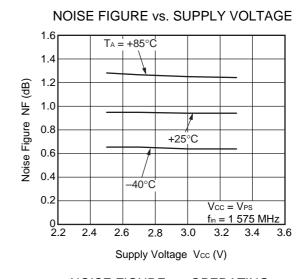


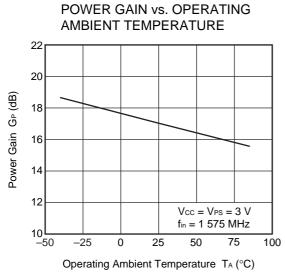
TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)



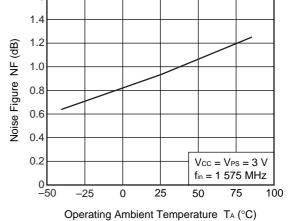




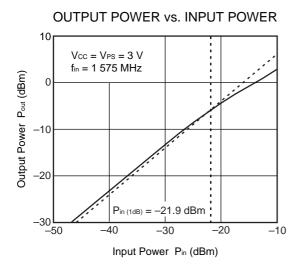


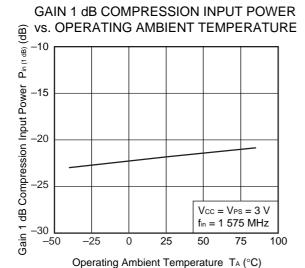


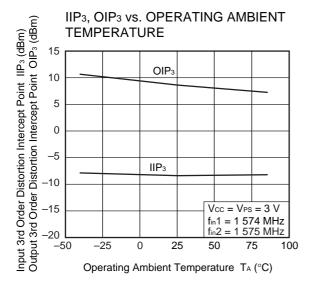
NOISE FIGURE vs. OPERATING AMBIENT TEMPERATURE



Remark The graphs indicate nominal characteristics.

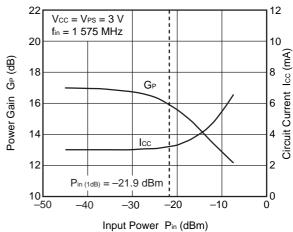




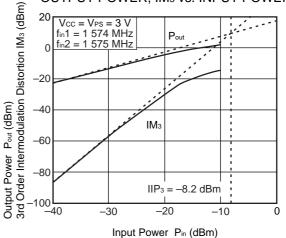


Remark The graphs indicate nominal characteristics.

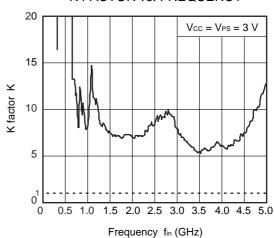




OUTPUT POWER, IM3 vs. INPUT POWER



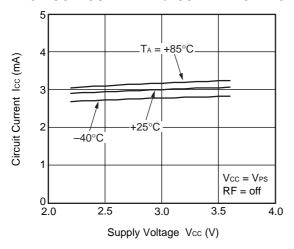
K FACTOR vs. FREQUENCY



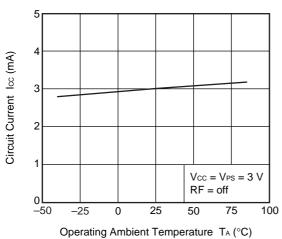
Vcc = 3 VRF = off

3.0

CIRCUIT CURRENT vs. SUPPLY VOLTAGE



CIRCUIT CURRENT vs. OPERATING AMBIENT TEMPERATURE



Remark The graphs indicate nominal characteristics.

CIRCUIT CURRENT vs. POWER-SAVING VOLTAGE TA = +85°C TA = +85°C -40°C -40°C -40°C

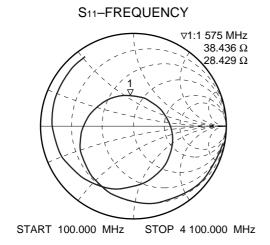
Power-Saving Voltage VPS (V)

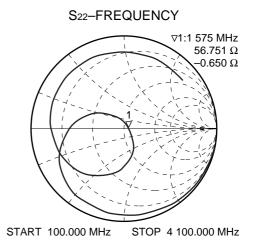
0

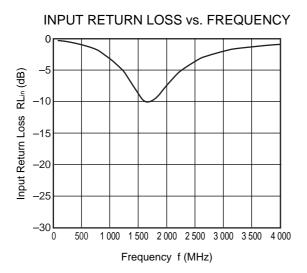
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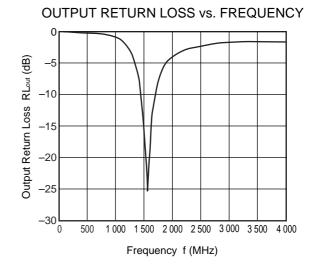
0.5

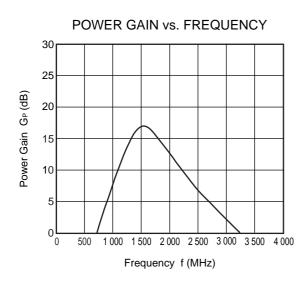
S-PARAMETERS (TA = +25°C, Vcc = Vps = 3.0 V, monitored at connector on board)

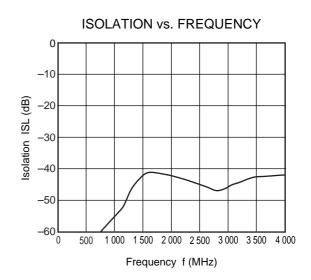








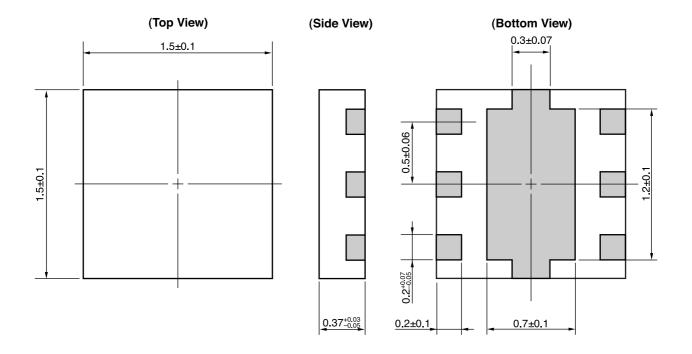




Remark The graphs indicate nominal characteristics.

PACKAGE DIMENSIONS

6-PIN PLASTIC TSON (UNIT: mm)



NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.
- (4) Do not supply DC voltage to INPUT pin.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not De	etected	
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not De	etected	
PBDE	< 1000 PPM	Not Detected		

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